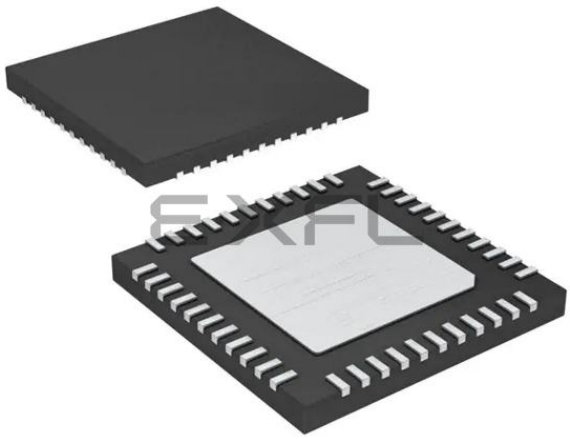

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f442-e-ml

TABLE 1-3: PIC18F4X2 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	DIP	PLCC	TQFP			
						PORTD is a bi-directional I/O port, or a Parallel Slave Port (PSP) for interfacing to a microprocessor port. These pins have TTL input buffers when PSP module is enabled.
RD0/PSP0	19	21	38	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD1/PSP1	20	22	39	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD2/PSP2	21	23	40	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD3/PSP3	22	24	41	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD4/PSP4	27	30	2	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD5/PSP5	28	31	3	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD6/PSP6	29	32	4	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
RD7/PSP7	30	33	5	I/O	ST TTL	Digital I/O. Parallel Slave Port Data.
						PORTE is a bi-directional I/O port.
RE0/$\overline{RD}$/AN5 RE0 $\overline{RD}$ AN5	8	9	25	I/O 	 ST TTL Analog	 Digital I/O. Read control for parallel slave port (see also $\overline{WR}$ and $\overline{CS}$ pins). Analog input 5.
RE1/$\overline{WR}$/AN6 RE1 $\overline{WR}$ AN6	9	10	26	I/O 	 ST TTL Analog	 Digital I/O. Write control for parallel slave port (see $\overline{CS}$ and $\overline{RD}$ pins). Analog input 6.
RE2/$\overline{CS}$/AN7 RE2 $\overline{CS}$ AN7	10	11	27	I/O 	 ST TTL Analog	 Digital I/O. Chip Select control for parallel slave port (see related $\overline{RD}$ and $\overline{WR}$). Analog input 7.
VSS	12, 31	13, 34	6, 29	P	—	Ground reference for logic and I/O pins.
VDD	11, 32	12, 35	7, 28	P	—	Positive supply for logic and I/O pins.

Legend: TTL = TTL compatible input
CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels
I = Input
O = Output
P = Power
OD = Open Drain (no P diode to VDD)

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Ranges Tested:			
Mode	**Freq**	**C1**	**C2**
LP	32.0 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	22-68 pF	22-68 pF
	1.0 MHz	15 pF	15 pF
	4.0 MHz	15 pF	15 pF
HS	4.0 MHz	15 pF	15 pF
	8.0 MHz	15-33 pF	15-33 pF
	20.0 MHz	15-33 pF	15-33 pF
	25.0 MHz	15-33 pF	15-33 pF
These values are for design guidance only. See notes following this table.			
Crystals Used			
32.0 kHz	Epson C-001R32.768K-A		± 20 PPM
200 kHz	STD XTL 200.000KHz		± 20 PPM
1.0 MHz	ECS ECS-10-13-1		± 50 PPM
4.0 MHz	ECS ECS-40-20-1		± 50 PPM
8.0 MHz	Epson CA-301 8.000M-C		± 30 PPM
20.0 MHz	Epson CA-301 20.000M-C		± 30 PPM

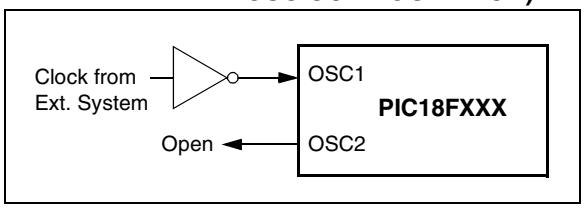
Note 1: Higher capacitance increases the stability of the oscillator, but also increases the start-up time.

2: Rs may be required in HS mode, as well as XT mode, to avoid overdriving crystals with low drive level specification.

3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components., or verify oscillator performance.

An external clock source may also be connected to the OSC1 pin in the HS, XT and LP modes, as shown in Figure 2-2.

FIGURE 2-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)



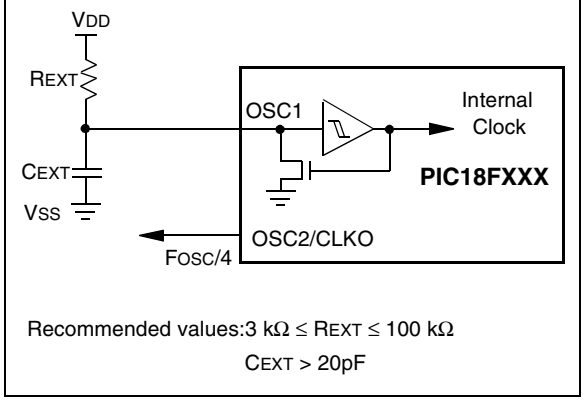
2.3 RC Oscillator

For timing-insensitive applications, the “RC” and “RCIO” device options offer additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 2-3 shows how the R/C combination is connected.

In the RC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic.

Note: If the oscillator frequency divided by 4 signal is not required in the application, it is recommended to use RCIO mode to save current.

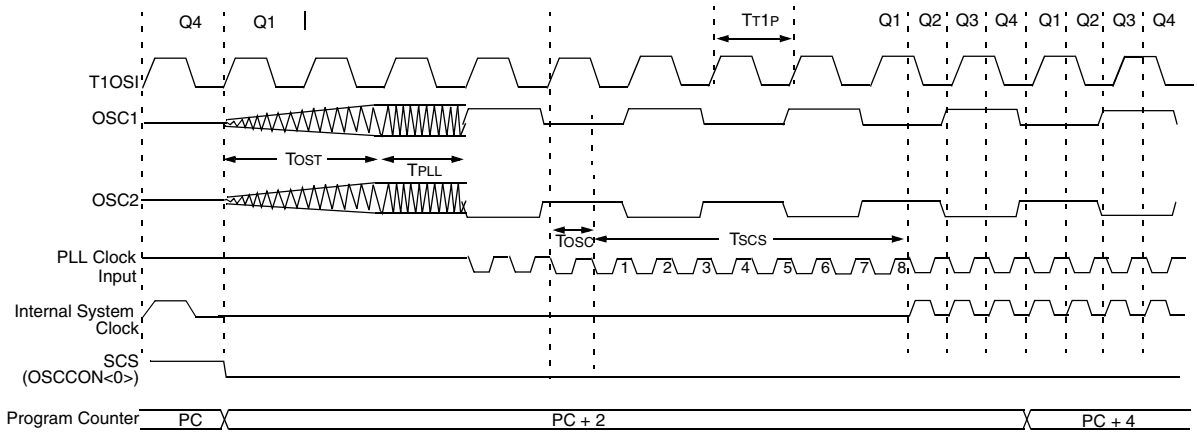
FIGURE 2-3: RC OSCILLATOR MODE



The RCIO Oscillator mode functions like the RC mode, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6).

If the main oscillator is configured for HS-PLL mode, an oscillator start-up time (TOST) plus an additional PLL time-out (TPLL) will occur. The PLL time-out is typically 2 ms and allows the PLL to lock to the main oscillator frequency. A timing diagram indicating the transition from the Timer1 oscillator to the main oscillator for HS-PLL mode is shown in Figure 2-10.

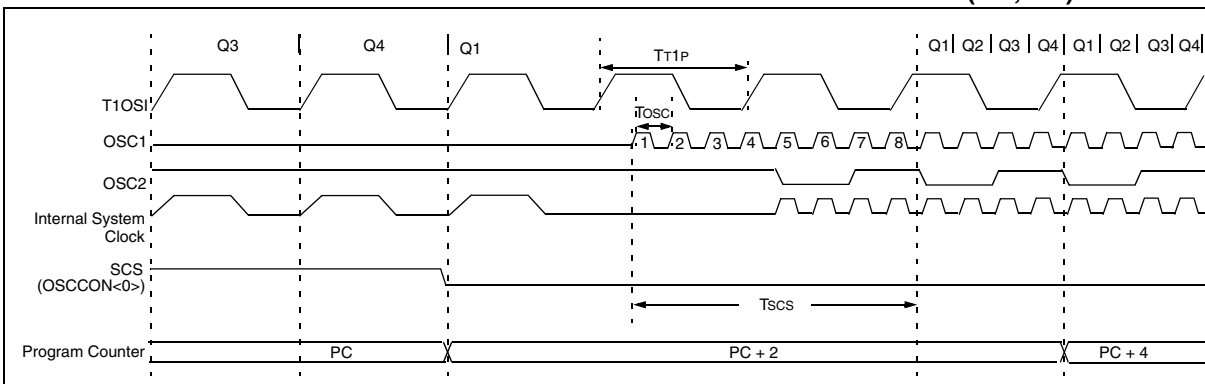
FIGURE 2-10: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (HS WITH PLL)



Note 1: TOST = 1024 TOSC (drawing not to scale).

If the main oscillator is configured in the RC, RCIO, EC or ECIO modes, there is no oscillator start-up time-out. Operation will resume after eight cycles of the main oscillator have been counted. A timing diagram, indicating the transition from the Timer1 oscillator to the main oscillator for RC, RCIO, EC and ECIO modes, is shown in Figure 2-11.

FIGURE 2-11: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (RC, EC)



Note 1: RC Oscillator mode assumed.

4.0 MEMORY ORGANIZATION

There are three memory blocks in Enhanced MCU devices. These memory blocks are:

- Program Memory
- Data RAM
- Data EEPROM

Data and program memory use separate busses, which allows for concurrent access of these blocks.

Additional detailed information for FLASH program memory and Data EEPROM is provided in Section 5.0 and Section 6.0, respectively.

4.1 Program Memory Organization

A 21-bit program counter is capable of addressing the 2-Mbyte program memory space. Accessing a location between the physically implemented memory and the 2-Mbyte address will cause a read of all '0's (a `NOP` instruction).

The PIC18F252 and PIC18F452 each have 32 Kbytes of FLASH memory, while the PIC18F242 and PIC18F442 have 16 Kbytes of FLASH. This means that PIC18FX52 devices can store up to 16K of single word instructions, and PIC18FX42 devices can store up to 8K of single word instructions.

The RESET vector address is at 0000h and the interrupt vector addresses are at 0008h and 0018h.

Figure 4-1 shows the Program Memory Map for PIC18F242/442 devices and Figure 4-2 shows the Program Memory Map for PIC18F252/452 devices.

TABLE 4-2: REGISTER FILE SUMMARY

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
TOSU	—	—	—	Top-of-Stack upper Byte (TOS<20:16>)					---0 0000	37
TOSH	Top-of-Stack High Byte (TOS<15:8>)								0000 0000	37
TOSL	Top-of-Stack Low Byte (TOS<7:0>)								0000 0000	37
STKPTR	STKFUL	STKUNF	—	Return Stack Pointer					00-0 0000	38
PCLATU	—	—	—	Holding Register for PC<20:16>					---0 0000	39
PCLATH	Holding Register for PC<15:8>								0000 0000	39
PCL	PC Low Byte (PC<7:0>)								0000 0000	39
TBLPTRU	—	—	bit21(2)	Program Memory Table Pointer Upper Byte (TBLPTR<20:16>)					--00 0000	58
TBLPTRH	Program Memory Table Pointer High Byte (TBLPTR<15:8>)								0000 0000	58
TBLPTRL	Program Memory Table Pointer Low Byte (TBLPTR<7:0>)								0000 0000	58
TABLAT	Program Memory Table Latch								0000 0000	58
PRODH	Product Register High Byte								xxxx xxxx	71
PRODL	Product Register Low Byte								xxxx xxxx	71
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	75
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	—	TMR0IP	—	RBIP	1111 -1-1	76
INTCON3	INT2IP	INT1IP	—	INT2IE	INT1IE	—	INT2IF	INT1IF	11-0 0-00	77
INDF0	Uses contents of FSR0 to address data memory - value of FSR0 not changed (not a physical register)								n/a	50
POSTINC0	Uses contents of FSR0 to address data memory - value of FSR0 post-incremented (not a physical register)								n/a	50
POSTDEC0	Uses contents of FSR0 to address data memory - value of FSR0 post-decremented (not a physical register)								n/a	50
PREINC0	Uses contents of FSR0 to address data memory - value of FSR0 pre-incremented (not a physical register)								n/a	50
PLUSW0	Uses contents of FSR0 to address data memory - value of FSR0 (not a physical register). Offset by value in WREG.								n/a	50
FSR0H	—	—	—	—	Indirect Data Memory Address Pointer 0 High Byte				---- 0000	50
FSR0L	Indirect Data Memory Address Pointer 0 Low Byte								xxxx xxxx	50
WREG	Working Register								xxxx xxxx	n/a
INDF1	Uses contents of FSR1 to address data memory - value of FSR1 not changed (not a physical register)								n/a	50
POSTINC1	Uses contents of FSR1 to address data memory - value of FSR1 post-incremented (not a physical register)								n/a	50
POSTDEC1	Uses contents of FSR1 to address data memory - value of FSR1 post-decremented (not a physical register)								n/a	50
PREINC1	Uses contents of FSR1 to address data memory - value of FSR1 pre-incremented (not a physical register)								n/a	50
PLUSW1	Uses contents of FSR1 to address data memory - value of FSR1 (not a physical register). Offset by value in WREG.								n/a	50
FSR1H	—	—	—	—	Indirect Data Memory Address Pointer 1 High Byte				---- 0000	50
FSR1L	Indirect Data Memory Address Pointer 1 Low Byte								xxxx xxxx	50
BSR	—	—	—	—	Bank Select Register				---- 0000	49
INDF2	Uses contents of FSR2 to address data memory - value of FSR2 not changed (not a physical register)								n/a	50
POSTINC2	Uses contents of FSR2 to address data memory - value of FSR2 post-incremented (not a physical register)								n/a	50
POSTDEC2	Uses contents of FSR2 to address data memory - value of FSR2 post-decremented (not a physical register)								n/a	50
PREINC2	Uses contents of FSR2 to address data memory - value of FSR2 pre-incremented (not a physical register)								n/a	50
PLUSW2	Uses contents of FSR2 to address data memory - value of FSR2 (not a physical register). Offset by value in WREG.								n/a	50
FSR2H	—	—	—	—	Indirect Data Memory Address Pointer 2 High Byte				---- 0000	50
FSR2L	Indirect Data Memory Address Pointer 2 Low Byte								xxxx xxxx	50
STATUS	—	—	—	N	OV	Z	DC	C	---x xxxx	52
TMR0H	Timer0 Register High Byte								0000 0000	105
TMR0L	Timer0 Register Low Byte								xxxx xxxx	105
T0CON	TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	1111 1111	103

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition

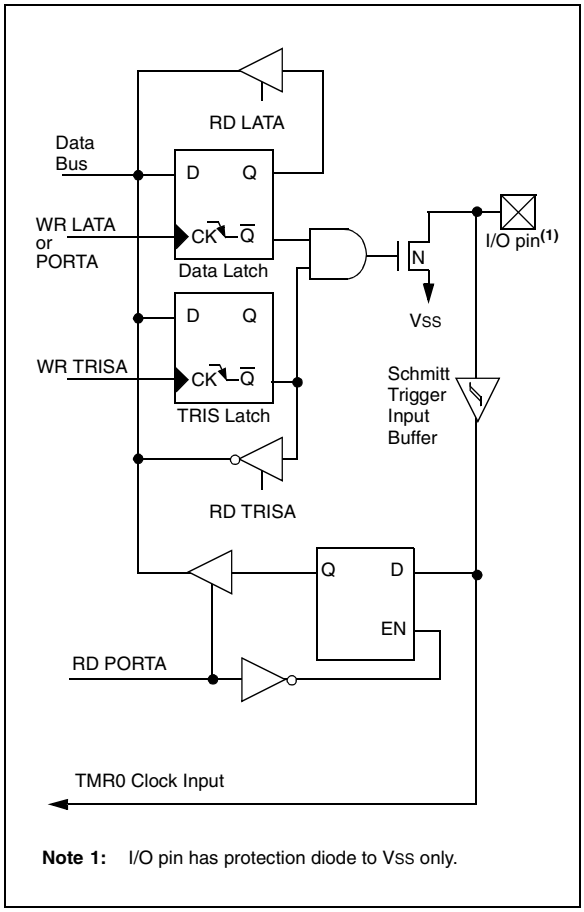
Note 1: RA6 and associated bits are configured as port pins in RCIO and ECIO Oscillator mode only and read '0' in all other Oscillator modes.

2: Bit 21 of the TBLPTRU allows access to the device configuration bits.

3: These registers and bits are reserved on the PIC18F2X2 devices; always maintain these clear.

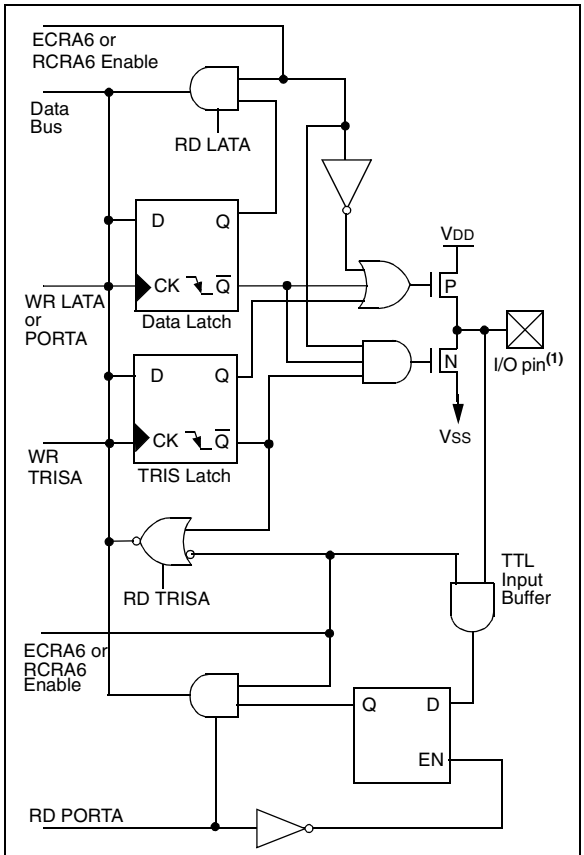
NOTES:

FIGURE 9-2: BLOCK DIAGRAM OF RA4/T0CKI PIN



Note 1: I/O pin has protection diode to VSS only.

FIGURE 9-3: BLOCK DIAGRAM OF RA6 PIN



Note 1: I/O pins have protection diodes to VDD and VSS.

FIGURE 9-12: PARALLEL SLAVE PORT READ WAVEFORMS

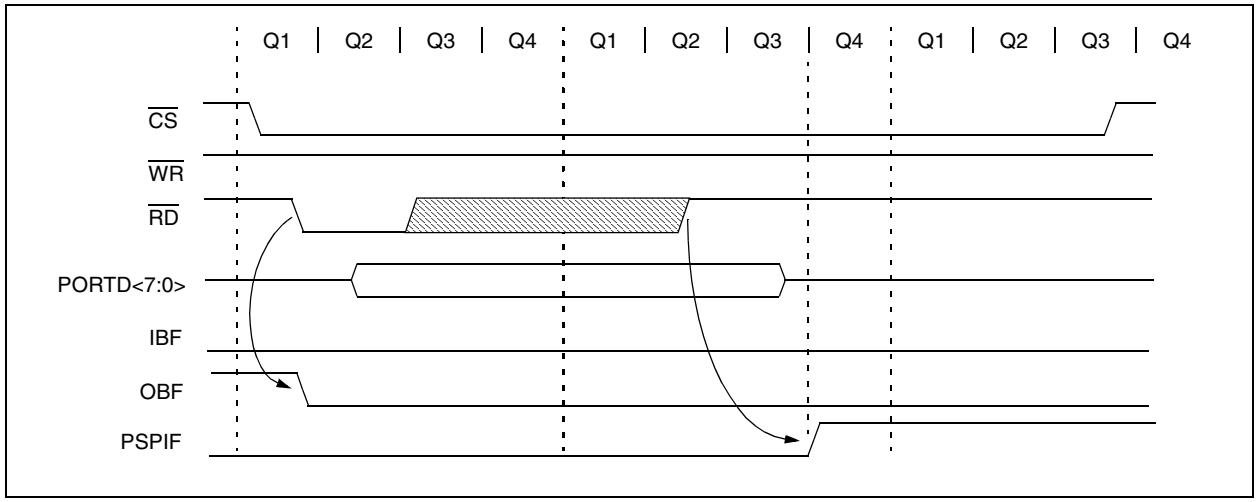


TABLE 9-11: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
PORTD	Port Data Latch when written; Port pins when read								xxxx xxxx	uuuu uuuu
LATD	LATD Data Output bits								xxxx xxxx	uuuu uuuu
TRISD	PORTD Data Direction bits								1111 1111	1111 1111
PORTE	—	—	—	—	—	RE2	RE1	RE0	---- -000	---- -000
LATE	—	—	—	—	—	LATE Data Output bits			---- -xxx	---- -uuu
TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction bits			0000 -111	0000 -111
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IF	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	PSPIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
PIE1	PSPIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
IPR1	PSPIP	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	0000 0000	0000 0000
ADCON1	ADFM	ADCS2	—	—	PCFG3	PCFG2	PCFG1	PCFG0	00-- 0000	00-- 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Parallel Slave Port.

13.2 Timer1 Oscillator

The Timer1 oscillator may be used as the clock source for Timer3. The Timer1 oscillator is enabled by setting the T1OSCEN (T1CON<3>) bit. The oscillator is a low power oscillator rated up to 200 KHz. See Section 11.0 for further details.

13.3 Timer3 Interrupt

The TMR3 Register pair (TMR3H:TMR3L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR3 Interrupt, if enabled, is generated on overflow, which is latched in interrupt flag bit, TMR3IF (PIR2<1>). This interrupt can be enabled/disabled by setting/clearing TMR3 interrupt enable bit, TMR3IE (PIE2<1>).

13.4 Resetting Timer3 Using a CCP Trigger Output

If the CCP module is configured in Compare mode to generate a “special event trigger” (CCP1M3:CCP1M0 = 1011), this signal will reset Timer3.

Note:	The special event triggers from the CCP module will not set interrupt flag bit, TMR3IF (PIR1<0>).

Timer3 must be configured for either Timer or Synchronized Counter mode to take advantage of this feature. If Timer3 is running in Asynchronous Counter mode, this RESET operation may not work. In the event that a write to Timer3 coincides with a special event trigger from CCP1, the write will take precedence. In this mode of operation, the CCPR1H:CCPR1L registers pair effectively becomes the period register for Timer3.

TABLE 13-1: REGISTERS ASSOCIATED WITH TIMER3 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR2	—	—	—	EEIF	BCLIF	LVDIF	TMR3IF	CCP2IF	---0 0000	---0 0000
PIE2	—	—	—	EEIE	BCLIE	LVDIE	TMR3IE	CCP2IE	---0 0000	---0 0000
IPR2	—	—	—	EEIP	BCLIP	LVDIP	TMR3IP	CCP2IP	---1 1111	---1 1111
TMR3L	Holding Register for the Least Significant Byte of the 16-bit TMR3 Register								xxxx xxxx	uuuu uuuu
TMR3H	Holding Register for the Most Significant Byte of the 16-bit TMR3 Register								xxxx xxxx	uuuu uuuu
T1CON	RD16	—	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{\text{T1SYNC}}$	TMR1CS	TMR1ON	0-00 0000	u-uu uuuu
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	$\overline{\text{T3SYNC}}$	TMR3CS	TMR3ON	0000 0000	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

15.3.1 REGISTERS

The MSSP module has four registers for SPI mode operation. These are:

- MSSP Control Register1 (SSPCON1)
- MSSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- MSSP Shift Register (SSPSR) - Not directly accessible

SSPCON1 and SSPSTAT are the control and status registers in SPI mode operation. The SSPCON1 register is readable and writable. The lower 6 bits of the SSPSTAT are read only. The upper two bits of the SSPSTAT are read/write.

SSPSR is the shift register used for shifting data in or out. SSPBUF is the buffer register to which data bytes are written to or read from.

In receive operations, SSPSR and SSPBUF together create a double buffered receiver. When SSPSR receives a complete byte, it is transferred to SSPBUF and the SSPIF interrupt is set.

During transmission, the SSPBUF is not double buffered. A write to SSPBUF will write to both SSPBUF and SSPSR.

REGISTER 15-1: SSPSTAT: MSSP STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF
bit 7							bit 0

bit 7 **SMP:** Sample bit
SPI Master mode:
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time
SPI Slave mode:
SMP must be cleared when SPI is used in Slave mode

bit 6 **CKE:** SPI Clock Edge Select
When CKP = 0:
1 = Data transmitted on rising edge of SCK
0 = Data transmitted on falling edge of SCK
When CKP = 1:
1 = Data transmitted on falling edge of SCK
0 = Data transmitted on rising edge of SCK

bit 5 **D/$\overline{A}$:** Data/$\overline{\text{Address}}$ bit
Used in I^2C mode only

bit 4 **P:** STOP bit
Used in I^2C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.

bit 3 **S:** START bit
Used in I^2C mode only

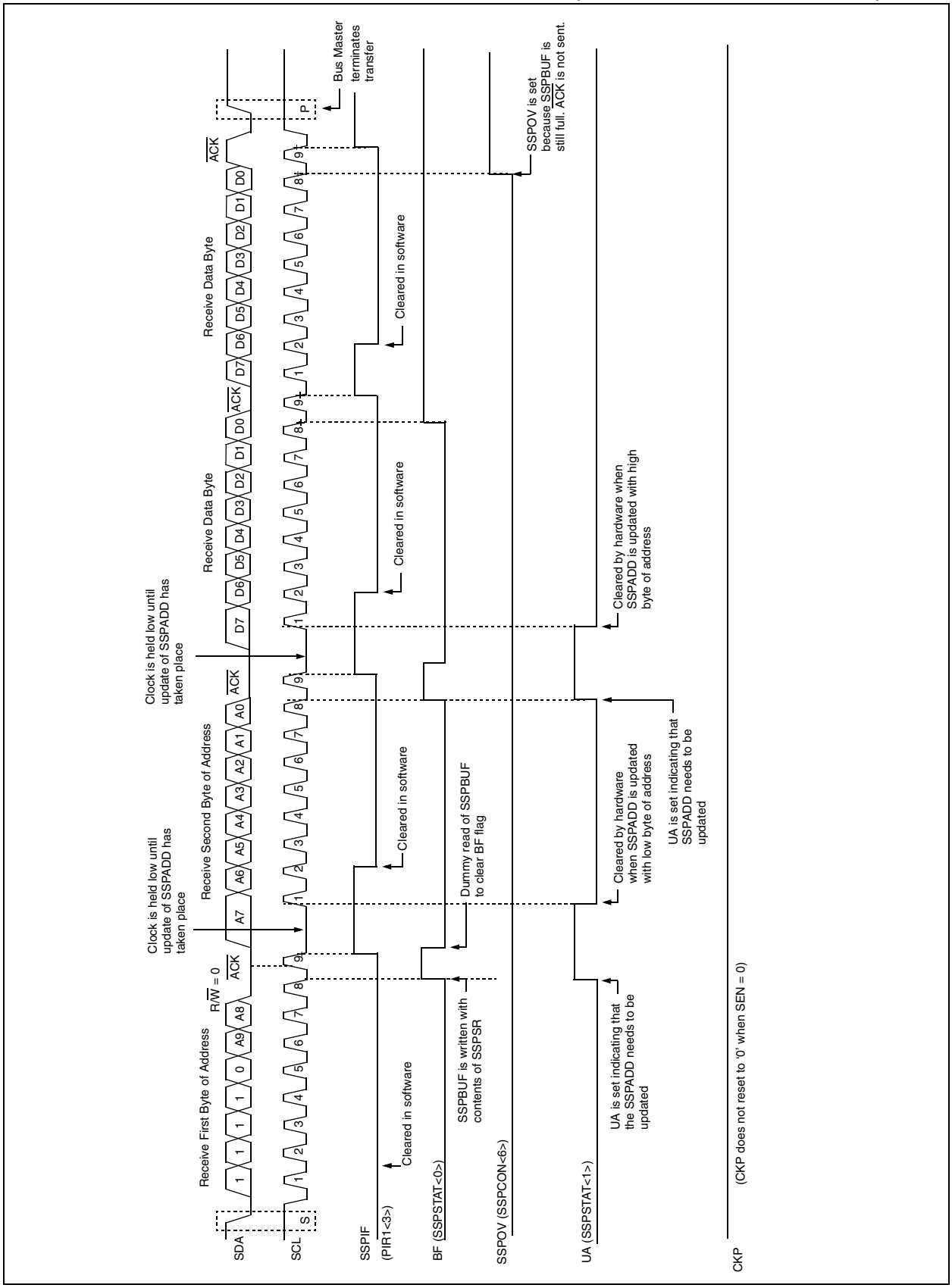
bit 2 **R/$\overline{W}$:** Read/Write bit information
Used in I^2C mode only

bit 1 **UA:** Update Address
Used in I^2C mode only

bit 0 **BF:** Buffer Full Status bit (Receive mode only)
1 = Receive complete, SSPBUF is full
0 = Receive not complete, SSPBUF is empty

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

FIGURE 15-10: I²C SLAVE MODE TIMING WITH SEN = 0 (RECEPTION, 10-BIT ADDRESS)



REGISTER 19-8: CONFIGURATION REGISTER 6 LOW (CONFIG6L: BYTE ADDRESS 30000Ah)

U-0	U-0	U-0	U-0	R/C-1	R/C-1	R/C-1	R/C-1
—	—	—	—	WRT3(1)	WRT2(1)	WRT1	WRT0
bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3 **WRT3:** Write Protection bit(1)
1 = Block 3 (006000-007FFFh) not write protected
0 = Block 3 (006000-007FFFh) write protected

bit 2 **WRT2:** Write Protection bit(1)
1 = Block 2 (004000-005FFFh) not write protected
0 = Block 2 (004000-005FFFh) write protected

bit 1 **WRT1:** Write Protection bit
1 = Block 1 (002000-003FFFh) not write protected
0 = Block 1 (002000-003FFFh) write protected

bit 0 **WRT0:** Write Protection bit
1 = Block 0 (000200h-001FFFh) not write protected
0 = Block 0 (000200h-001FFFh) write protected

Note 1: Unimplemented in PIC18FX42 devices; maintain this bit set.

Legend:		
R = Readable bit	C = Clearable bit	U = Unimplemented bit, read as '0'
- n = Value when device is unprogrammed		u = Unchanged from programmed state

REGISTER 19-9: CONFIGURATION REGISTER 6 HIGH (CONFIG6H: BYTE ADDRESS 30000Bh)

R/C-1	R/C-1	C-1	U-0	U-0	U-0	U-0	U-0
WRTD	WRTB	WRTC	—	—	—	—	—
bit 7							bit 0

bit 7 **WRTD:** Data EEPROM Write Protection bit
1 = Data EEPROM not write protected
0 = Data EEPROM write protected

bit 6 **WRTB:** Boot Block Write Protection bit
1 = Boot Block (000000-0001FFh) not write protected
0 = Boot Block (000000-0001FFh) write protected

bit 5 **WRTC:** Configuration Register Write Protection bit
1 = Configuration registers (300000-3000FFh) not write protected
0 = Configuration registers (300000-3000FFh) write protected

Note: This bit is read only, and cannot be changed in User mode.

bit 4-0 **Unimplemented:** Read as '0'

Legend:		
R = Readable bit	C =Clearable bit	U = Unimplemented bit, read as '0'
- n = Value when device is unprogrammed		u = Unchanged from programmed state

19.4.2 DATA EEPROM CODE PROTECTION

The entire Data EEPROM is protected from external reads and writes by two bits: CPD and WRTD. CPD inhibits external reads and writes of Data EEPROM. WRTD inhibits external writes to Data EEPROM. The CPU can continue to read and write Data EEPROM regardless of the protection bit settings.

19.4.3 CONFIGURATION REGISTER PROTECTION

The configuration registers can be write protected. The WRTC bit controls protection of the configuration registers. In User mode, the WRTC bit is readable only. WRTC can only be written via ICSP or an external programmer.

19.5 ID Locations

Eight memory locations (200000h - 200007h) are designated as ID locations, where the user can store checksum or other code identification numbers. These locations are accessible during normal execution through the TBLRD and TBLWT instructions, or during program/verify. The ID locations can be read when the device is code protected.

The sequence for programming the ID locations is similar to programming the FLASH memory (see Section 5.5.1).

19.6 In-Circuit Serial Programming

PIC18FXXX microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

19.7 In-Circuit Debugger

When the DEBUG bit in configuration register CONFIG4L is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB® IDE. When the microcontroller has this feature enabled, some of the resources are not available for general use. Table 19-4 shows which features are consumed by the background debugger.

TABLE 19-4: DEBUGGER RESOURCES

I/O pins	RB6, RB7
Stack	2 levels
Program Memory	512 bytes
Data Memory	10 bytes

To use the In-Circuit Debugger function of the microcontroller, the design must implement In-Circuit Serial Programming connections to $\overline{MCLR}/V_{PP}$, V_{DD}, GND, RB7 and RB6. This will interface to the In-Circuit Debugger module available from Microchip or one of the third party development tool companies.

19.8 Low Voltage ICSP Programming

The LVP bit configuration register CONFIG4L enables low voltage ICSP programming. This mode allows the microcontroller to be programmed via ICSP using a V_{DD} source in the operating voltage range. This only means that V_{PP} does not have to be brought to V_{IHH}, but can instead be left at the normal operating voltage. In this mode, the RB5/PGM pin is dedicated to the programming function and ceases to be a general purpose I/O pin. During programming, V_{DD} is applied to the $\overline{MCLR}/V_{PP}$ pin. To enter Programming mode, V_{DD} must be applied to the RB5/PGM, provided the LVP bit is set. The LVP bit defaults to a (‘1’) from the factory.

Note 1: The High Voltage Programming mode is always available, regardless of the state of the LVP bit, by applying V_{IHH} to the $\overline{MCLR}$ pin.

2: While in low voltage ICSP mode, the RB5 pin can no longer be used as a general purpose I/O pin, and should be held low during normal operation to protect against inadvertent ICSP mode entry.

3: When using low voltage ICSP programming (LVP), the pull-up on RB5 becomes disabled. If TRISB bit 5 is cleared, thereby setting RB5 as an output, LATB bit 5 must also be cleared for proper operation.

If Low Voltage Programming mode is not used, the LVP bit can be programmed to a '0' and RB5/PGM becomes a digital I/O pin. However, the LVP bit may only be programmed when programming is entered with V_{IHH} on $\overline{MCLR}/V_{PP}$.

It should be noted that once the LVP bit is programmed to 0, only the High Voltage Programming mode is available and only High Voltage Programming mode can be used to program the device.

When using low voltage ICSP, the part must be supplied 4.5V to 5.5V, if a bulk erase will be executed. This includes reprogramming of the code protect bits from an on-state to off-state. For all other cases of low voltage ICSP, the part may be programmed at the normal operating voltage. This means unique user IDs, or user code can be reprogrammed or added.

TABLE 20-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit a = 0: RAM location in Access RAM (BSR register is ignored) a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7)
BSR	Bank Select Register. Used to select the current RAM bank.
d	Destination select bit; d = 0: store result in WREG, d = 1: store result in file register f.
dest	Destination either the WREG register or the specified register file location
f	8-bit Register file address (0x00 to 0xFF)
fs	12-bit Register file address (0x000 to 0xFFF). This is the source address.
fd	12-bit Register file address (0x000 to 0xFFF). This is the destination address.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value)
label	Label name
mm * *+ *- +*	The mode of the TBLPTR register for the Table Read and Table Write instructions. Only used with Table Read and Table Write instructions: No Change to register (such as TBLPTR with Table reads and writes) Post-Increment register (such as TBLPTR with Table reads and writes) Post-Decrement register (such as TBLPTR with Table reads and writes) Pre-Increment register (such as TBLPTR with Table reads and writes)
n	The relative address (2's complement number) for relative branch instructions, or the direct address for Call/Branch and Return instructions
PRODH	Product of Multiply high byte
PRODL	Product of Multiply low byte
s	Fast Call/Return mode select bit. s = 0: do not update into/from shadow registers s = 1: certain registers loaded into/from shadow registers (Fast mode)
u	Unused or Unchanged
WREG	Working register (accumulator)
x	Don't care (0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
TBLPTR	21-bit Table Pointer (points to a Program Memory location)
TABLAT	8-bit Table Latch
TOS	Top-of-Stack
PC	Program Counter
PCL	Program Counter Low Byte
PCH	Program Counter High Byte
PCLATH	Program Counter High Byte Latch
PCLATU	Program Counter Upper Byte Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer
$\overline{TO}$	Time-out bit
$\overline{PD}$	Power-down bit
C, DC, Z, OV, N	ALU status bits Carry, Digit Carry, Zero, Overflow, Negative
[ ]	Optional
( )	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
italics	User defined term (font is courier)

BCF **Bit Clear f**

Syntax: [*label*] BCF f,b[,a]

Operands: $0 \le f \le 255$
$0 \le b \le 7$
$a \in [0,1]$

Operation: $0 \rightarrow f<b>$

Status Affected: None

Encoding:

1001	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is cleared. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BCF FLAG_REG, 7, 0`

Before Instruction
FLAG_REG = 0xC7
After Instruction
FLAG_REG = 0x47

BN **Branch if Negative**

Syntax: [*label*] BN n

Operands: $-128 \le n \le 127$

Operation: if negative bit is '1'
$(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1110	0110	nnnn	nnnn

Description: If the Negative bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BN   Jump
```
Before Instruction
PC = address (HERE)
After Instruction
If Negative = 1;
PC = address (Jump)
If Negative = 0;
PC = address (HERE+2)

FIGURE 23-21: TYPICAL, MINIMUM AND MAXIMUM V_{OH} vs. I_{OH} (V_{DD} = 5V, -40°C TO +125°C)

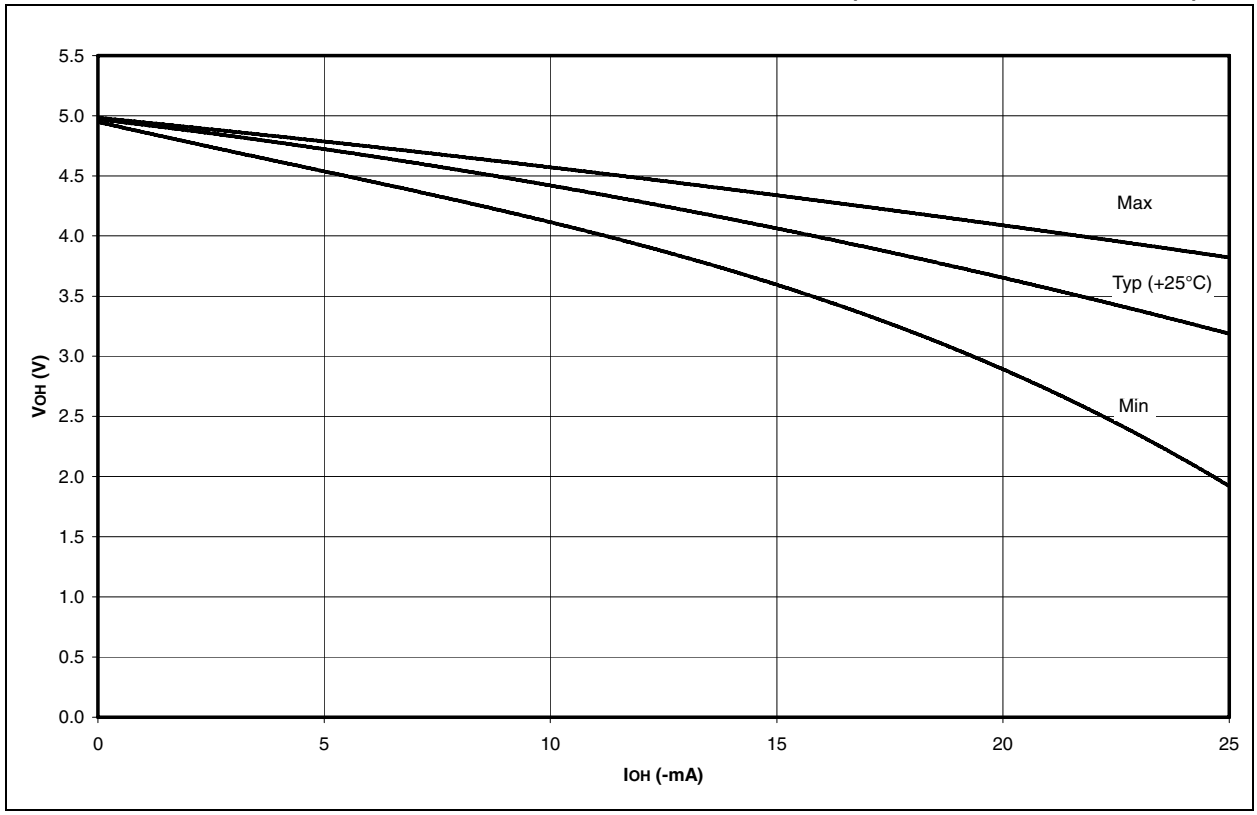


FIGURE 23-22: TYPICAL, MINIMUM AND MAXIMUM V_{OH} vs. I_{OH} (V_{DD} = 3V, -40°C TO +125°C)

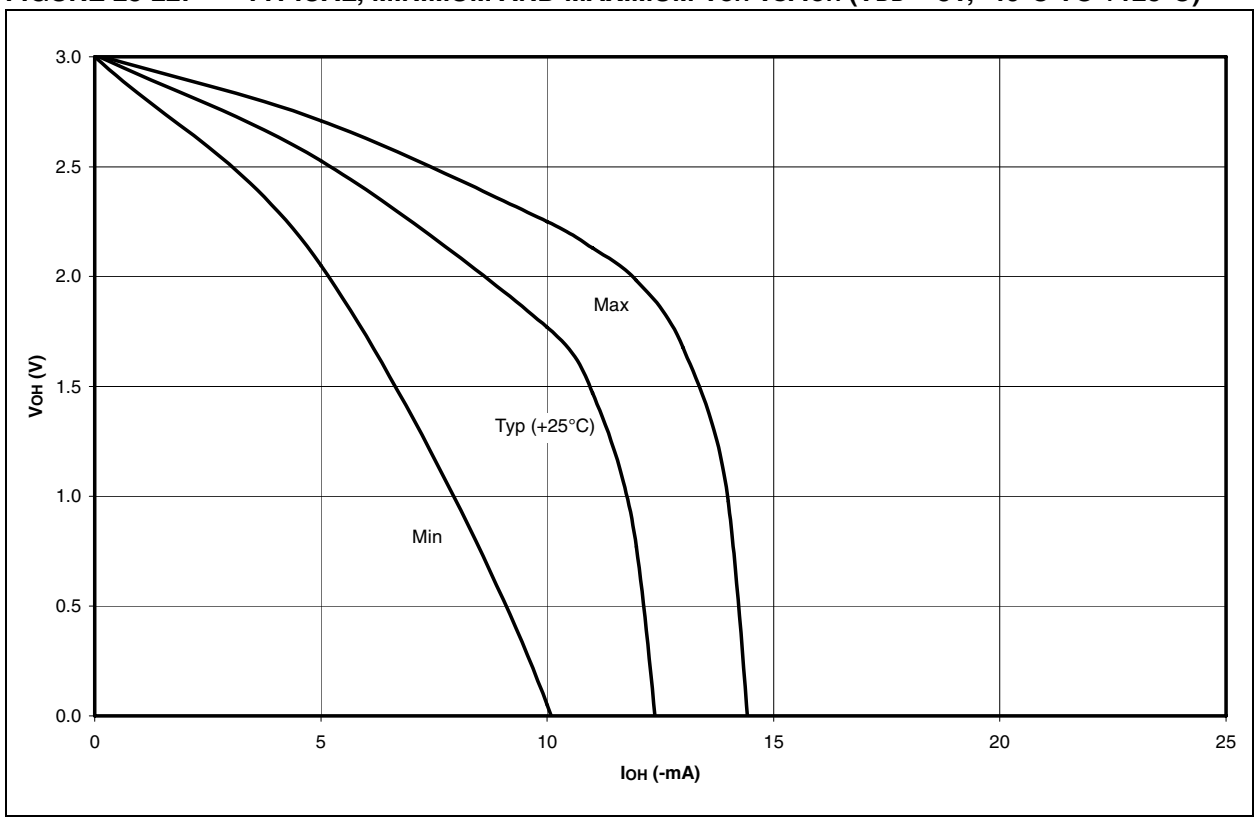


FIGURE 23-23: TYPICAL AND MAXIMUM VOL vs. IOL (VDD = 5V, -40°C TO +125°C)

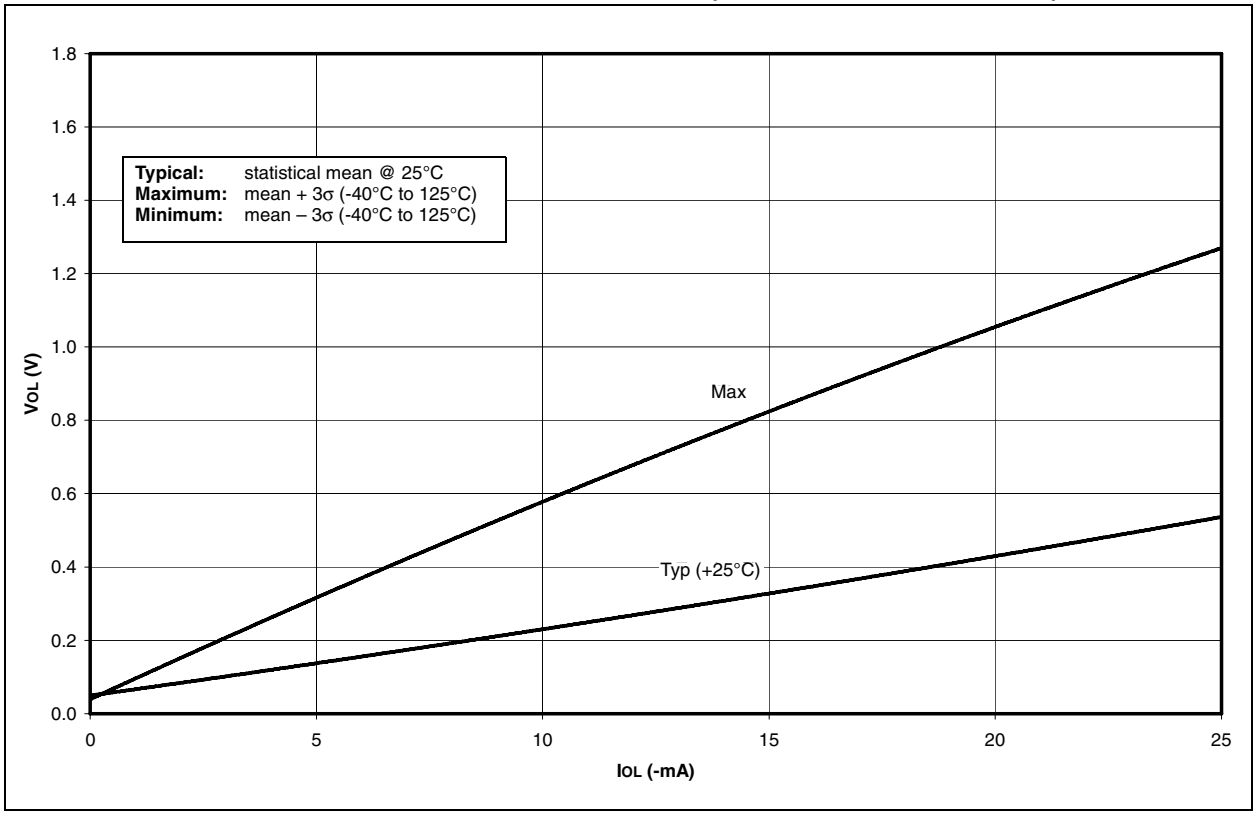
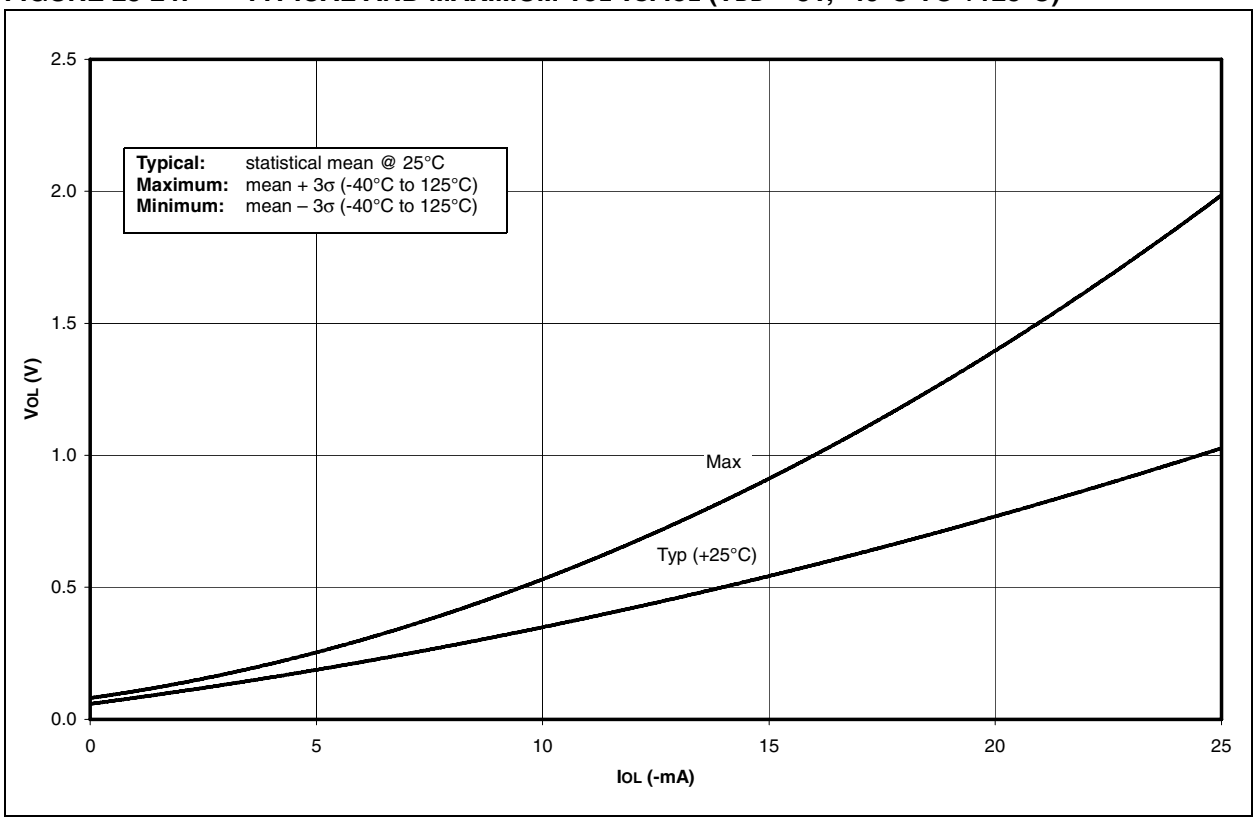


FIGURE 23-24: TYPICAL AND MAXIMUM VOL vs. IOL (VDD = 3V, -40°C TO +125°C)



NOTES:

APPENDIX C: CONVERSION CONSIDERATIONS

This appendix discusses the considerations for converting from previous versions of a device to the ones listed in this data sheet. Typically, these changes are due to the differences in the process technology used. An example of this type of conversion is from a PIC16C74A to a PIC16C74B.

Not Applicable

APPENDIX D: MIGRATION FROM BASELINE TO ENHANCED DEVICES

This section discusses how to migrate from a Baseline device (i.e., PIC16C5X) to an Enhanced MCU device (i.e., PIC18FXXX).

The following are the list of modifications over the PIC16C5X microcontroller family:

Not Currently Available

P

